

SOLO V2 – LPM



Why choose SOLO V2?

- **Compact design**
- **Low start-up costs**
- **Low maintenance**
- **Flex-Tool ready**
- **High efficiency**
- **Lease-to-own option**

Suitable materials and properties

- *Thermelt® 861 – Standard Material for Low Pressure Moulding*

*A **high-flow, easy-processing copolyamide** designed for **low pressure moulding** of strain-relief moulding. connectors and electronic components.*

- *Thermelt® 865 – Flexible All-Round Solution for Electronics*

***low viscosity & high flexibility** ideal for strain-relief moulding, connectors & delicate electronics.*

- *Thermelt® 867 HV – High Strength for Demanding Environments*

*A reinforced copolyamide formulation with **enhanced mechanical strength and thermal resistance**, designed for components exposed to vibration, moisture, and oil.*